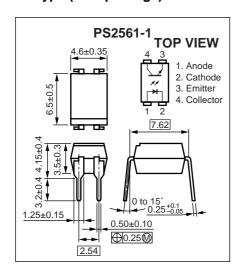
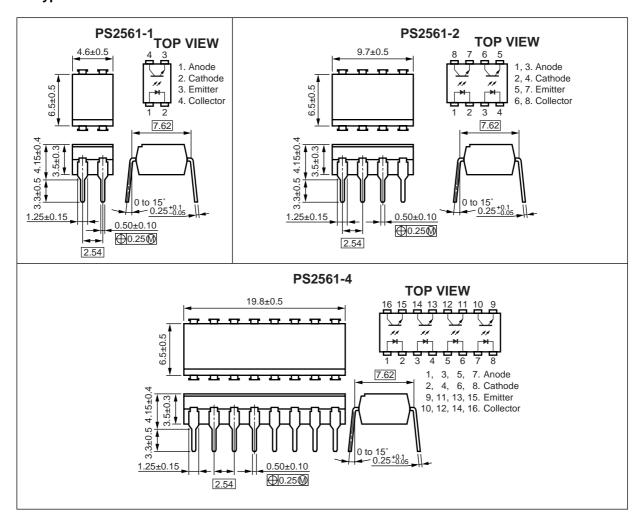
* PACKAGE DIMENSIONS (UNIT : mm)

DIP Type (New package)

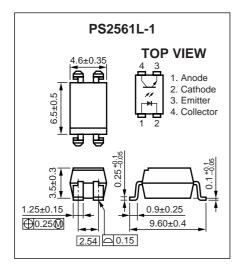


Caution New package 1-ch only

DIP Type

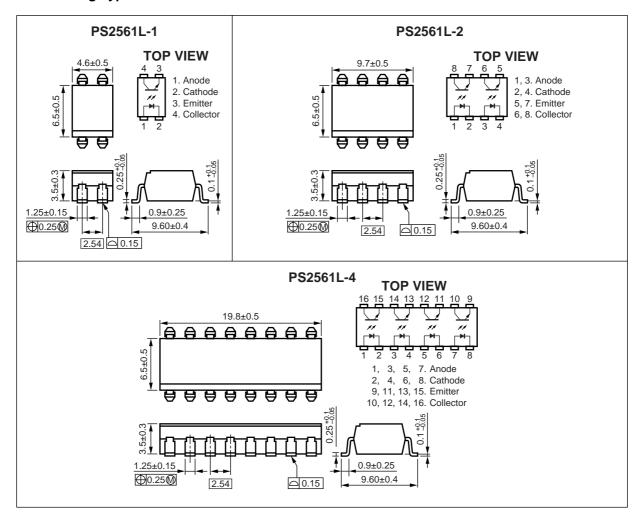


Lead Bending Type (New package)

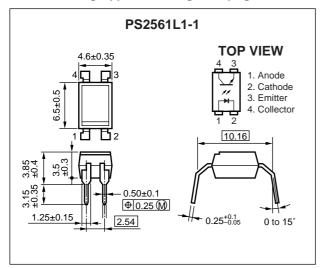


Caution New package 1-ch only

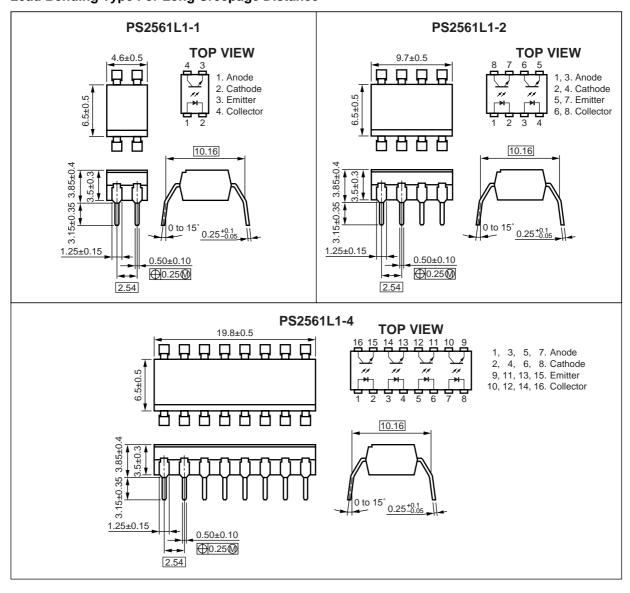
Lead Bending Type



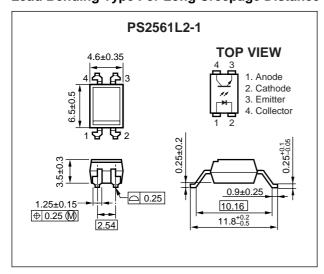
Lead Bending Type For Long Creepage Distance (New Package)



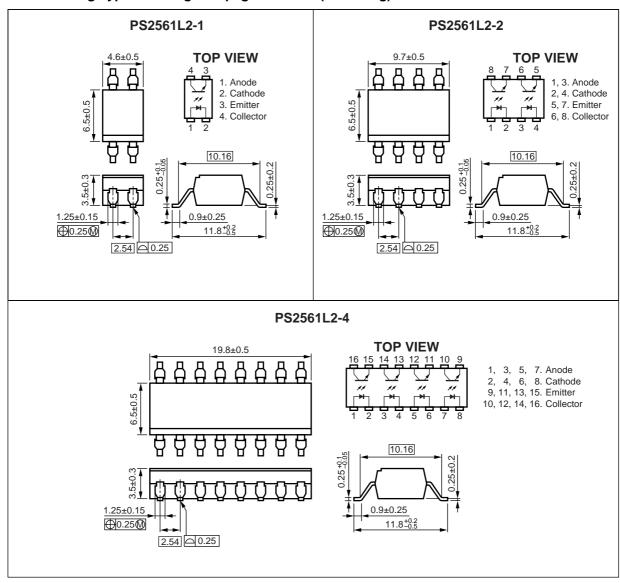
Lead Bending Type For Long Creepage Distance



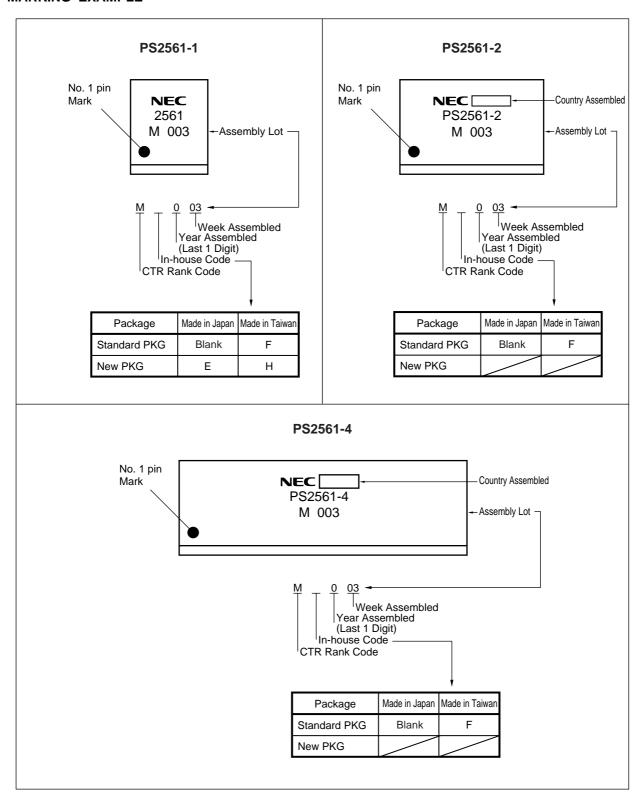
Lead Bending Type For Long Creepage Distance (Gull-Wing) (New Package)



Lead Bending Type For Long Creepage Distance (Gull-Wing)



★ MARKING EXAMPLE



★ ORDERING INFORMATION (Solder Contains Lead) (1/2)

Part Number	Package	Packing Style	Safety Standard Approval	Application Part Number*1
PS2561-1	4-pin DIP	Magazine case 100 pcs	Standard products	PS2561-1
PS2561L-1			(UL, CSA, BSI,	
PS2561L1-1			NEMKO, SEMKO,	
PS2561L2-1			DEMKO, FIMKO	
PS2561L-1-E3		Embossed Tape 1 000 pcs/reel	approved)	
PS2561L-1-E4				
PS2561L-1-F3		Embossed Tape 2 000 pcs/reel		
PS2561L-1-F4				
PS2561L2-1-E3		Embossed Tape 1 000 pcs/reel		
PS2561L2-1-E4				
PS2561-2	8-pin DIP	Magazine case 45 pcs		PS2561-2
PS2561L-2				
PS2561L1-2				
PS2561L2-2				
PS2561L-2-E3		Embossed Tape 1 000 pcs/reel		
PS2561L-2-E4				
PS2561-4	16-pin DIP	Magazine case 20 pcs		PS2561-4
PS2561L-4				
PS2561L1-4				
PS2561L2-4				
PS2561-1-V	4-pin DIP	Magazine case 100 pcs	VDE approved	PS2561-1
PS2561L-1-V			products (Option)	
PS2561L1-1-V				
PS2561L2-1-V				
PS2561L-1-V-E3		Embossed Tape 1 000 pcs/reel		
PS2561L-1-V-E4				
PS2561L-1-V-F3		Embossed Tape 2 000 pcs/reel		
PS2561L-1-V-F4				
PS2561L2-1-V-E3		Embossed Tape 1 000 pcs/reel		
PS2561L2-1-V-E4				

^{*1} For the application of the Safety Standard, following part number should be used.

7

ORDERING INFORMATION (Solder Contains Lead) (2/2)

Part Number	Package	Packing Style	Safety Standard Approval	Application Part Number*1
PS2561-2-V	8-pin DIP	Magazine case 45 pcs	VDE approved	PS2561-2
PS2561L-2-V			products (Option)	
PS2561L1-2-V				
PS2561L2-2-V				
PS2561L-2-V-E3		Embossed Tape 1 000 pcs/reel		
PS2561L-2-V-E4				
PS2561-4-V	16-pin DIP	Magazine case 20 pcs		PS2561-4
PS2561L-4-V				
PS2561L1-4-V				
PS2561L2-4-V				

^{*1} For the application of the Safety Standard, following part number should be used.

★ ORDERING INFORMATION (Pb-Free) (1/2)

Part Number	Package	Packing Style	Safety Standard Approval	Application Part Number*1
PS2561-1-A	4-pin DIP	Magazine case 100 pcs	Standard products	PS2561-1
PS2561L-1-A			(UL, CSA, BSI,	
PS2561L1-1-A			NEMKO, SEMKO,	
PS2561L2-1-A			DEMKO, FIMKO	
PS2561L-1-E3-A		Embossed Tape 1 000 pcs/reel	approved)	
PS2561L-1-E4-A				
PS2561L-1-F3-A		Embossed Tape 2 000 pcs/reel		
PS2561L-1-F4-A				
PS2561L2-1-E3-A		Embossed Tape 1 000 pcs/reel		
PS2561L2-1-E4-A				
PS2561-2-A	8-pin DIP	Magazine case 45 pcs		PS2561-2
PS2561L-2-A				
PS2561L1-2-A				
PS2561L2-2-A				
PS2561L-2-E3-A		Embossed Tape 1 000 pcs/reel		
PS2561L-2-E4-A				
PS2561-4-A	16-pin DIP	Magazine case 20 pcs		PS2561-4
PS2561L-4-A				
PS2561L1-4-A				
PS2561L2-4-A				
PS2561-1-V-A	4-pin DIP	Magazine case 100 pcs	VDE approved	PS2561-1
PS2561L-1-V-A			products (Option)	
PS2561L1-1-V-A				
PS2561L2-1-V-A				
PS2561L-1-V-E3-A		Embossed Tape 1 000 pcs/reel		
PS2561L-1-V-E4-A	1			
PS2561L-1-V-F3-A	1	Embossed Tape 2 000 pcs/reel		
PS2561L-1-V-F4-A	1			
PS2561L2-1-V-E3-A	1	Embossed Tape 1 000 pcs/reel		
PS2561L2-1-V-E4-A				

^{*1} For the application of the Safety Standard, following part number should be used.

ORDERING INFORMATION (Pb-Free) (2/2)

Part Number	Package	Packing Style	Safety Standard Approval	Application Part Number*1
PS2561-2-V-A	8-pin DIP	Magazine case 45 pcs	VDE approved	PS2561-2
PS2561L-2-V-A			products (Option)	
PS2561L1-2-V-A				
PS2561L2-2-V-A				
PS2561L-2-V-E3-A		Embossed Tape 1 000 pcs/reel		
PS2561L-2-V-E4-A				
PS2561-4-V-A	16-pin DIP	Magazine case 20 pcs		PS2561-4
PS2561L-4-V-A				
PS2561L1-4-V-A				
PS2561L2-4-V-A				

^{*1} For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C, unless otherwise specified)

	Parameter		Ratings		Unit
			PS2561-1	PS2561-2,-4	
Diode	Reverse Voltage	VR	(3	V
	Forward Current (DC)	lF	8	0	mA
	Power Dissipation Derating	⊿P _D /°C	1.5	1.2	mW/°C
	Power Dissipation	PD	150	120	mW/ch
	Peak Forward Current*1	I FP	1		Α
Transistor	Collector to Emitter Voltage	VCEO	80		٧
	Emitter to Collector Voltage	VECO	7		\
	Collector Current	lc	5	0	mA/ch
	Power Dissipation Derating	⊿Pc/°C	1.5	1.2	mW/°C
	Power Dissipation	Pc	150 120		mW/ch
Isolation Vo	Isolation Voltage*2		5 000		Vr.m.s.
Operating A	Operating Ambient Temperature		-55 to +100		°C
Storage Te	Storage Temperature		-55 to +150		°C

^{*1} PW = 100 μ s, Duty Cycle = 1 %

^{*2} AC voltage for 1 minute at T_A = 25 °C, RH = 60 % between input and output

ELECTRICAL CHARACTERISTICS (TA = 25 °C)

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA		1.17	1.4	V
	Reverse Current	lR	V _R = 5 V			5	μА
	Terminal Capacitance	Ct	V = 0 V, f = 1.0 MHz		50		pF
Transistor	Collector to Emitter Dark Current	Iceo	VcE = 80 V, IF = 0 mA			100	nA
Coupled	Current Transfer Ratio (Ic/I _F) ^{*1}	CTR	IF = 5 mA, VcE = 5 V	80	200	400	%
	Collector Saturation Voltage	VCE (sat)	IF = 10 mA, Ic = 2 mA			0.3	V
	Isolation Resistance	R _{I-O}	Vi-o = 1.0 kVpc	10 ¹¹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1.0 MHz		0.5		pF
	Rise Time ^{*2}	tr	$Vcc = 10 \text{ V}, \text{ Ic} = 2 \text{ mA}, \text{ R}_L = 100 \Omega$		3		μS
	Fall Time*2	t _f			5		

★ *1 CTR rank (only PS2561-1, PS2561L-1, PS2561L1-1, PS2561L2-1)

L : 200 to 400 (%)

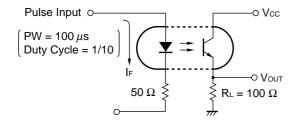
M : 80 to 240 (%)

D : 100 to 300 (%)

H : 80 to 160 (%)

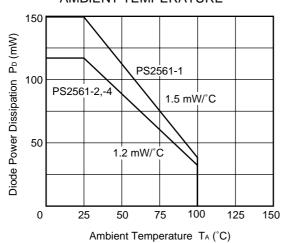
W : 130 to 260 (%)

*2 Test circuit for switching time

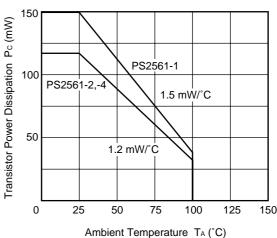


TYPICAL CHARACTERISTICS (TA = 25 °C, unless otherwise specified)

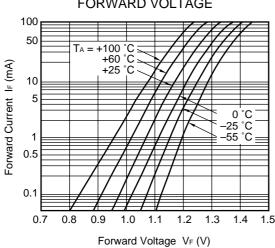
★ DIODE POWER DISSIPATION vs. AMBIENT TEMPERATURE



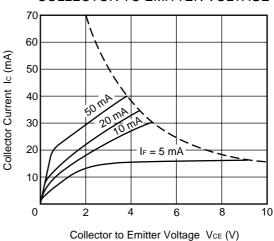
TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



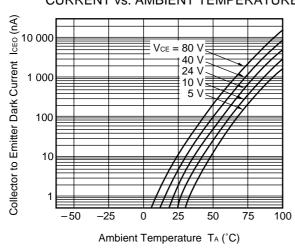
FORWARD CURRENT vs. FORWARD VOLTAGE



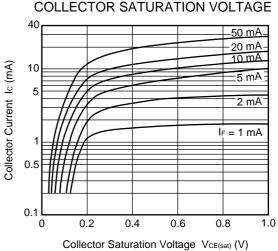
COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE



COLLECTOR TO EMITTER DARK CURRENT vs. AMBIENT TEMPERATURE

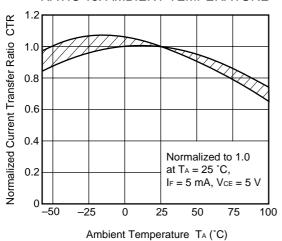


COLLECTOR CURRENT vs.

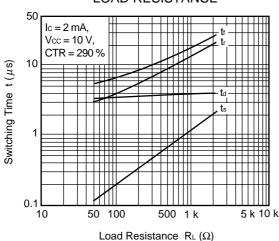


Remark The graphs indicate nominal characteristics.

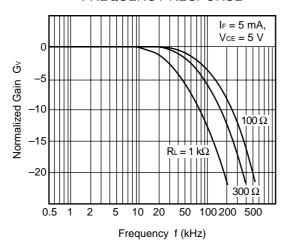
NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



SWITCHING TIME vs. LOAD RESISTANCE

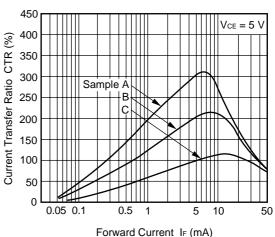


FREQUENCY RESPONSE

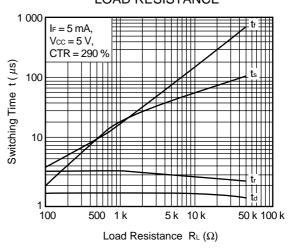


Remark The graphs indicate nominal characteristics.

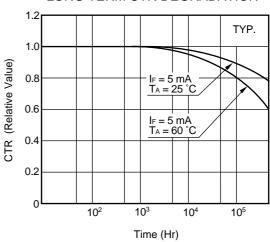
CURRENT TRANSFER RATIO vs. FORWARD CURRENT



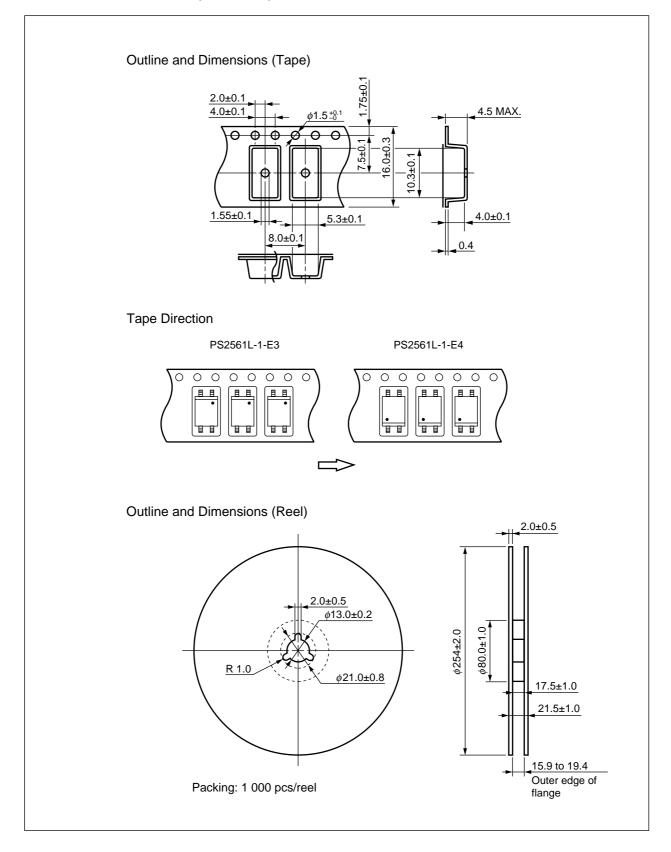
SWITCHING TIME vs. LOAD RESISTANCE

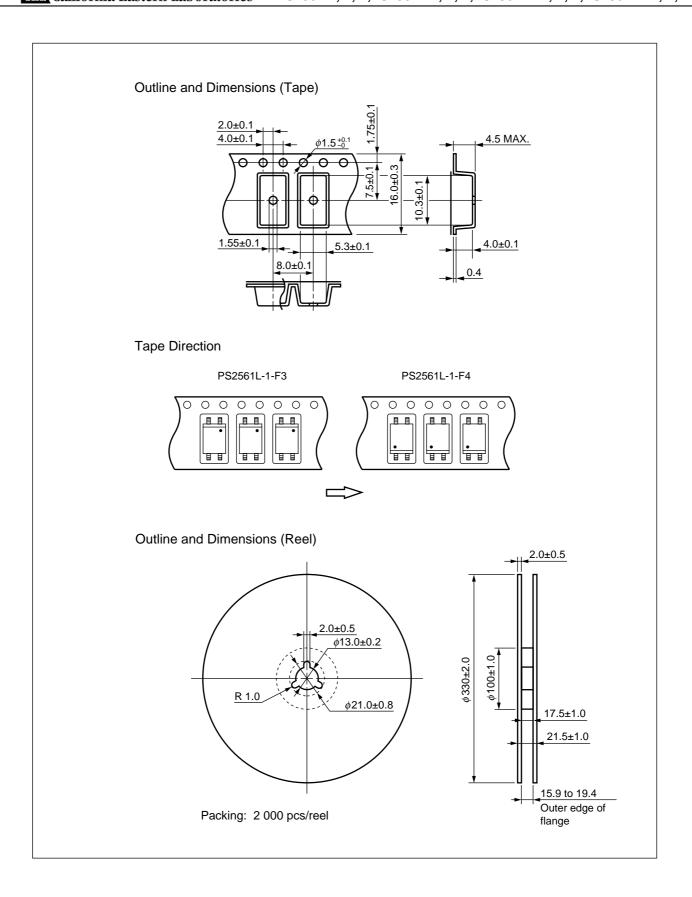


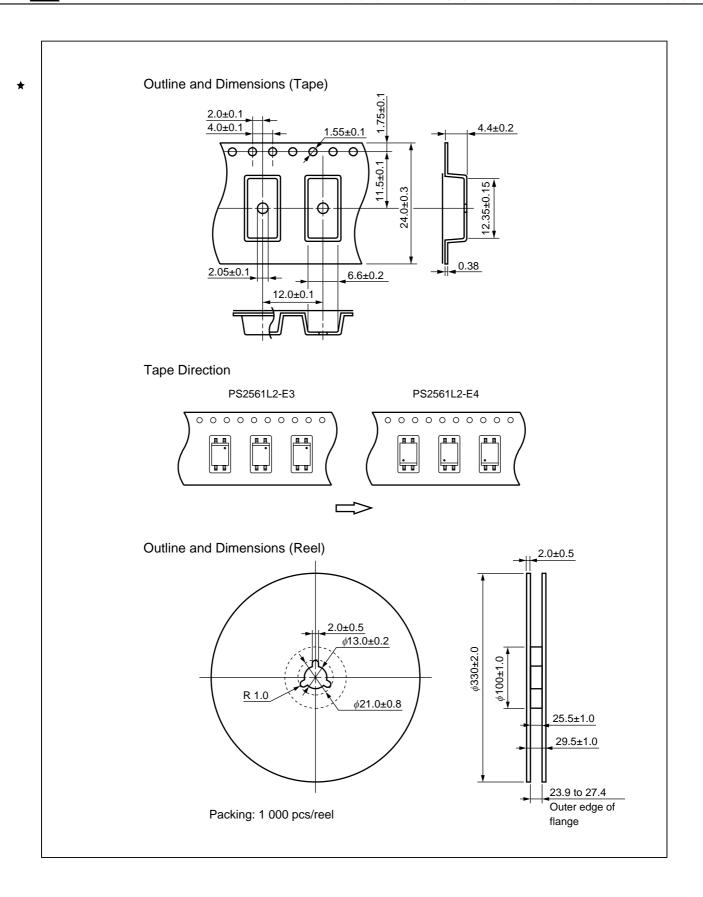
LONG TERM CTR DEGRADATION

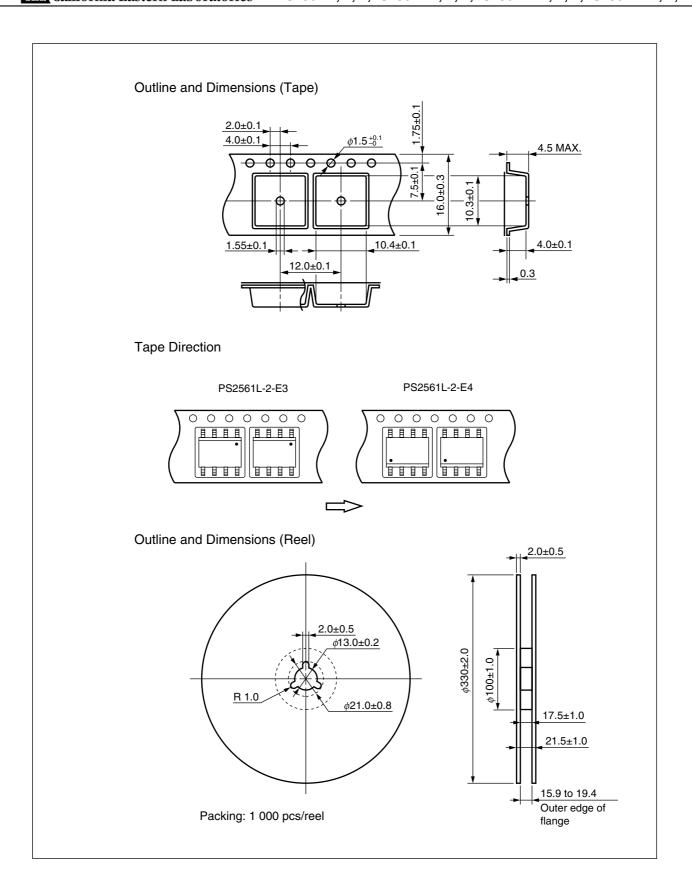


TAPING SPECIFICATIONS (UNIT: mm)









NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

• Peak reflow temperature 260°C or below (package surface temperature)

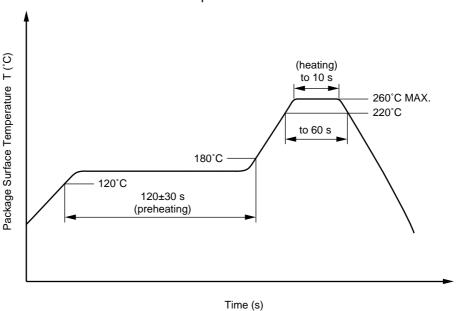
• Time of peak reflow temperature 10 seconds or less • Time of temperature higher than 220°C 60 seconds or less

• Time to preheat temperature from 120 to 180°C 120±30 s · Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

• Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

· Preheating conditions 120°C or below (package surface temperature)

· Number of times One (Allowed to be dipped in solder including plastic mold portion.)

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

(3) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output side may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Speck	Unit
Application classification (DIN VDE 0109) for rated line voltages ≤ 300 Vr.m.s. for rated line voltages ≤ 600 Vr.m.s.		IV III	
Climatic test class (DIN IEC 68 Teil 1/09.80)		55/100/21	
Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.2 \times U_{IORM}$, $P_d < 5 \ pC$	Uiorm Upr	890 1 068	V _{peak} V _{peak}
Test voltage (partial discharge test, procedure b for all devices test) $U_{pr} = 1.6 \times U_{IORM}, P_d < 5 pC$	Upr	1 424	V _{peak}
Highest permissible overvoltage	Utr	8 000	V _{peak}
Degree of pollution (DIN VDE 0109)		2	
Clearance distance		> 7.0	mm
Creepage distance		> 7.0	mm
Comparative tracking index (DIN IEC 112/VDE 0303 part 1)	СТІ	175	
Material group (DIN VDE 0109)		III a	
Storage temperature range	T _{stg}	-55 to +150	°C
Operating temperature range	TA	-55 to +100	°C
Isolation resistance, minimum value VIO = 500 V dc at TA = 25 °C VIO = 500 V dc at TA MAX. at least 100 °C	Ris MIN. Ris MIN.	10 ¹² 10 ¹¹	Ω Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) Package temperature Current (input current I _F , Psi = 0) Power (output or total power dissipation)	Tsi Isi Psi	175 400 700	°C mA mW
Isolation resistance Vio = 500 V dc at T _A = 175 °C (Tsi)	Ris MIN.	10 ⁹	Ω



4590 Patrick Henry Drive Santa Clara, CA 95054-1817 Telephone: (408) 919-2500 Facsimile: (408) 988-0279

Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentration contained in CEL devices		
Lead (Pb)	< 1000 PPM	-A -AZ Not Detected (*)		
Mercury	< 1000 PPM	Not Detected		
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	< 1000 PPM	Not Detected		
PBB	< 1000 PPM	Not Detected		
PBDE	< 1000 PPM	Not Detected		

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

Important Information and Disclaimer: Information provided by CEL on its website or in other communications concerting the substance content of its products represents knowledge and belief as of the date that it is provided. CEL bases its knowledge and belief on information provided by third parties and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. CEL has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. CEL and CEL suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release

In no event shall CEL's liability arising out of such information exceed the total purchase price of the CEL part(s) at issue sold by CEL to customer on an annual basis.

See CEL Terms and Conditions for additional clarification of warranties and liability.